

Lenovo P14s Gen 6 AMD

Version: 2.0 | 10/16/2025

Product Name	P14s Gen 6 AMD						
Product Display Name	P14s Gen 6 AMD						
Information Date	23-Apr-24						

SECTION I: Platform Overview

Description		The Lenovo ThinkPad P14s AMD, our thinnest and lightest mobile workstation, enables accelerated productivity and seamless multitasking for professionals on the move.						
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CPU

Processor Support		AMD Krackan Point Ryzen AI 7 PRO 350 & Ryzen AI 5 PRO 340 AMD Strix Point Ryzen AI 9 HX PRO 370						
Socket Type		BGA						
Disclaimers								

Operating Systems

Preloaded		Windows 11 Pro 64 (Win11 2024) Windows 11 Home 64 Windows 11 Home Chinese Language Edition 64 Ubuntu Fedora						
Supported		Windows 11 Pro 64 (Win11 2024) Windows 11 Home 64 Windows 11 Home Chinese Language Edition 64 Ubuntu Fedora Redhat						
Disclaimers								

Memory

Number of DIMM Slots		2 SoDIMM slot						
Channels		Quad 32b channels						
Type		DDR5						
ECC Support		No						
Speed		5600MT/S						
Max DIMM Size		48GB						
Max System Memory		96GB						
Min System Memory		16GB						
Soldered Memory		NO						
Disclaimers								

Storage

Storage Slots		1 x PCIe Gen 4 M.2 2280						
SATA		/						
PCIe		Solid State Drive, OPAL2 PCIe-NVMe Gen 4 M.2 2280-TLC						
SAS		None						
Interface		PCIe Gen 4						
Security		PCIE						
Optional Hard Disk		OPAL2 for NVMe SSD						

Drive Controllers								
Disclaimers								

Video

Integrated Graphics		AMD Radeon™ 890M (Ryzen AI 9 HX PRO 370) AMD Radeon™ 860M (Ryzen AI 7 PRO 350) AMD Radeon™ 840M (Ryzen AI 5 PRO 340)						
Discrete Graphics		N/A						
Adapter		None						
Bus Interface		NA						
Disclaimers								

Display

Resolutions		FHD+ (1920 x 1200) / 2.8k OLED (2880 x 1800)						
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Camera

Resolution		5MP RGB+IR/ 5MP RGB						
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Frames per Second		30 fps						
Focus		Fixed 50cm						
Camera Interface		USB 2.0						
IR Camera		Yes (optional)						

Keyboard

Number of Keys		US : 84 / UK : 85 / JP : 89						
Numpad		No						
Size		100% ISO						
Function Key Features		Yes						
Backlit		Yes						
Keyboard size		CS24 Top mount Shrunken 14" KBD						
Key stroke		1.5mm (normal keys), 1.35mm (Fn keys)						
Key pitch		19.05mm						
Keyboard backlight		Optional						
Keyboard thickness		4.0mm (General)						

TrackPad / Fingerprint Reader

TrackPoint Details		COMO TrackPoint						
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		module (t5.5mm)						
Finger Print Reader Model		Synaprics Metallica 8×8 FPR, MoC						
Multi-Touch		Yes						
Resolution		1000 ppi						
TrackPad/Tou chPad thickness		3.3mm						
TrackPad/Tou chPad type		3 BCP						
TrackPad size		115mm x 61 mm						
TrackPad material/finis h		Mylar surface						

I/O – Ports and Connectors

USB		2x USB-A 3.2 (Gen 1) (1 powered)						
Thunderbolt		2x USB-C (USB4.0, TBT4, DP2.0)						
HDMI		1x HDMI 2.1 TMDS up to 4K/60Hz						
Audio Combo Jack		1x Microphone & Headphone Combo Jack (3.5mm)						
Media Card Reader		N/A						
Smart Card Reader		Yes (optional)						

Power Connector		DC-In						
Docking Port		2x USB-C						
VirtualLink		None						
Network adapter		Gigabit Ethernet (RJ45)						
Disclaimers								

Power Connector

Main		DC-In						
USB-C		2x USB-C (USB4.0, TBT4, DP2.0)						
Disclaimers								

Ethernet

Vendor		Realtek						
Count		x1						
EEPROM		SPI ROM (Merge with BIOS/MEFW)						
Speeds		10/100/1000 Mbps						
Functions		Wake On LAN MAC Address Pass Through PXE Boot Flash Over LAN						
Connectors		RJ45						
Disclaimers								

WWAN

Model		Optional :5G Module Quectel RM520N-G /Cat16 Quectel EM160R-GL GEN2						
Disclaimers								

Near Field Communications

Model		Yes , optional						
Disclaimers								

Audio

Vendor		Realtek						
Type		High Definition Audio Codec						
Internal Speaker		Yes, dual speakers						
Connectors		Microphone & Headphone Combo Jack (3.5mm)						
Chipset		ALC3287						
Number of Channels		4-channel DAC, 4- channel ADC						
Number of Bits/Audio Resolution		16/20/24-bit PCM format						

Sampling Rate (Recording/Playback)		n						
Signal to Noise Ratio		90dB Signal-to-Noise Ratio (A-weighting) for ADC input. 100dB Signal-to-Noise Ratio (A-weighting) for DAC output						
Analog Audio		None						
Dolby Digital		Yes						
Digital Out (S/PDIF)		No						
Speaker Power Rating		2W@4ohm/channel						
Disclaimers								

Power adapter

Type		PD 65W 2cable 110cc PCC90% 3pin	49cc GAN 65W PD3.0 USB-C, Wall Mount	80cc GAN 65W PD3.0 USB-C				
Dimensions		90x46x26.5mm	47x35x30mm	75.7x48x22mm				
Input Voltage		100-240V	100-240V	100-240V				
Disclaimers								

Security

TPM		Yes, TPM2.0						
Asset ID		Yes						

Pro		Yes						
Disclaimers								

Chassis Information

Format		Ultralim Notebook						
Color		Black						
Thermal Solutions		Internal Single FAN, Intelligent Cooling						
Dimensions		Length 315.90 millimeters Width 223.70 millimeters Height 16.13 mm (Rear)/ 10.9 mm (Front)						
Weight		Starting weight 1.39kg / 3.06lbs						
Disclaimers								

Packaging Parameters

Height (mm)		300						
Height (inch)		11.8						
Width (mm)		446						
Width (inch)		17.6						
Depth (mm)		81						
Depth (inch)		3.1						

Weight (kgs)		0.32kg						
Weight (lbs)		0.71lbs						
Disclaimers								

Security & Serviceability

Hardware Maintenance Manual								
Drivers & Software								
Self Healing BIOS		Yes						
Access Panel		Removeable bottom cover						
Number of Screws		6						
Swappable Components		Base cover assembly, TrackPoint pointing stick, Lenovo factory recovery USB key, Power cord, ac power adapter (65W)						
Storage Slots		1 storage slot						
Memory		two DIMM						
System Board		1190 System Board. No self-service CRU.						
Restore CD/DVD/USB Set		None. Purchase via Lenovo Customer						

		Support Center						
Cable Lock Support		Security-lock slot						
Power-On Password		Yes						
Hard Disk Password		Yes; User and Master hard disk password						
Supervisor Password		Yes						
NIC LEDs (integrated)		Yes (if it means the LED for Ethernet)						
Security Chip		Yes (for TPM 2.0)						
Access Panel Key Lock		Bottom Cover Tamper Detection						
Boot Sequence Control		Yes						
Disclaimers								

Operating Environment

Operating – Air Temperature		At altitudes up to 2438 m (8000 ft) – Operating: 5°C to 35°C (41°F to 95°F)						
Non Operating – Air Temperature		At altitudes up to 2438 m (8000 ft) – Storage: 5°C to 43°C (41°F to 109°F)						

Humidity		Operating: 8% to 95% at wet-bulb temperature 23°C (73°F) Storage: 5% to 95% at wet-bulb temperature 27°C (81°F)						
Corrosive Gas		G1						
Particulates		P1						
Disclaimers								

SECTION II: Platform Detail

Supported Components

Processor		AMD Krackan Point Ryzen AI 5 PRO 340 AMD Krackan Point Ryzen AI 7 PRO 350 AMD Strix Point Ryzen AI 9 HX PRO 370						
Memory Support		DDR5 5600MT/S						
Chipset (PCH)		Integrated Soc						
Size of BIOS Flash		64 MB						
Super I/O		N/A						
Clock		Crystal						

Audio		Realtek High Definition Audio						
Ethernet		Realtek RTL8111EPV						
Notes								
Disclaimers								

Memory

System Capacity Options		Upto 96GB						
non-ECC		Yes						
Brand of non-ECC Memory		Samsung/Ramaxe/Sk Hynix/Micron						
ECC		None						
Brand of ECC Memory		N/A						
Memory clock frequency(MHz)		DDR5 5600 MT/S						
Disclaimers								

Storage

2.5" SAS Hard Disk Drive (HDD)		None						
2.5" SATA Hard Disk Drive (HDD)		None						
2.5" SATA Solid State		None						

Drive (SSD)								
M.2 (NGFF) PCIe Solid State Drive (SSD)		256GB Opal 2 PCIe G4 NVMe M.2 2280 512GB Opal 2 PCIe G4 NVMe M.2 2280 512GB Opal 2 PCIe G4 NVMe Performance M.2 2280 1TB Opal 2 PCIe G4 NVMe M.2 2280 1TB Opal 2 PCIe G4 NVMe Performance M.2 2280 2TB Opal 2 PCIe Gen4 Performance NVMe M.2 2280						
2.5" PCIe Solid State Drive (SSD)		None						
Brand of Drive		Samsung UnionMem WD Hynix Kioxia Micron						
Intel Optane Storage Technology		Yes						
RAID		Not Supported						
RAID Level and Requirement s								
Disclaimers								

Removeable Media

Media Card Reader Specifications		N/A						
Disclaimers								

SECTION III: Supported Component Detail

CPU Specifications

CPU		AMD Krackan Point Ryzen AI 5 PRO 340	AMD Krackan Point Ryzen AI 7 PRO 350	AMD Strix Point Ryzen AI 9 HX PRO 370				
Integrated Graphics		AMD Radeon™ 840M	AMD Radeon™ 860M	AMD Radeon™ 890M				
# of Cores		6 cores	8 cores	12 Cores				
# of Threads		12	16	24				
Processor Base Frequency		2.0GHz	2.0GHz	2.0GHz				
Max Turbo Frequency		4.8GHz	5GHz	5.1GHz				
Cache		22MB	24MB	36MB				
TDP		29W	29W	29W				
AMD Spec Link								
Disclaimers								

Display Specifications

Model		WUXGA	WUXGA oncell touch	WUXGA low power	WUXGA ePrivacy	2.8k		
Resolution		1920 x 1200	1920 x 1200	1920 x 1200	1920 x 1200	2880 x 1800		
Diagonal		14"	14"	14"	14"	14"		
Aspect Ratio		Ratio 16:10	Ratio 16:10	Ratio 16:10	Ratio 16:10	Ratio 16:10		
Backlight		LED	LED	LED	LED	None		
PPI		162	162	162	162	243		
Active Area		302 x 188	302 x 188	302 x 188	302 x 188	302 x 188		
Refresh Rate		60 Hz	60 Hz	60 Hz	60Hz	120 Hz		
Contrast Ratio		800:1 (TYP)	800:1 (TYP)	1000:1 (TYP)	1500:1 (TYP)	100000:1 (TYP)		
Viewing Angle		85/85/85/85 degree	85/85/85/85 degree	85/85/85/85 degree	85/85/85/85 degree	85/85/85/85 degree		
Color gamut		45% NTSC	45% NTSC	100% sRGB	100% sRGB	100% DCI-P3		
Brightness		400nit	400nit	500nit	500nit	500nit		
Contrast		Ratio 800:1	Ratio 800:1	Ratio 1000:1	Ratio 1500:1	Ratio 100000:1		
Color Depth		16M	16M	16M	16M	1074M		
Interface		eDP 1.2	eDP 1.2	eDP 1.4	eDP 1.4	eDP 1.4		
Panel ID Recognition		EDID in BIOS Table	EDID in BIOS Table	EDID in BIOS Table	EDID in BIOS Table	EDID in BIOS Table		
Weight		305g max	310g max	245g max	270g max	180g max		
Color Calibrator		None	None	Adaptive ICC profile	None	X-Rite Factory Color Calibration, Dolby Vision		
Panel Technology		IPS, Anti-Glare	IPS, Anti-Glare	IPS, Anti-Glare, LBL, Eyesafe certified	IPS, Anti-Glare	OLED, Anti-Glare/Anti-reflection/Anti-fingerprint, LBL, Eyesafe certified		

Touch Panel		None	YES	None	YES	None		
Disclaimers								

HDD Specifications

2.5" SAS Hard Disk Drive (HDD)		N/A						
2.5" SATA Hard Disk Drive (HDD)		N/A						
Disclaimers								

HDD Storage Device Specifications

Connector		N/A						
Transfer Rate (Gb/sec)		N/A						
Disclaimers								

HDD Performance

Spindle Speed(RPM)		N/A						
Power off to Spindle Stop(sec)		N/A						
DC Power to Drive Ready(sec)		N/A						
Receipt of Start Unit Command to		N/A						

Drive Ready(sec)								
Average Latency(msec)		N/A						
Disclaimers								

HDD Power Management

Input (VDC)		N/A						
Typical (Watts)		N/A						
Idle (Watts)		N/A						
Disclaimers								

HDD Dimensions

Height (mm – Max)		N/A						
Width (mm)		N/A						
Depth (mm – Max)		N/A						
Weight (grams)		N/A						
Disclaimers								

HDD Temperature

Operating(C) Ambient		N/A						
Operating(C) Base Casting		N/A						

Non-Operating(C Ambient		N/A						
Gradient(C per Hour)		N/A						
Disclaimers								

HDD Shock

Operating(Gs @ 2ms)		N/A						
Non-Operating(Gs @ 2ms)		N/A						
Disclaimers								

SSD Specifications

2.5" SATA Solid State Drive (SSD)		N/A						
M.2 (NGFF) PCIe Solid State Drive (SSD)		1x M.2 2280 PCIe Gen4						
2.5" PCIe Solid State Drive (SSD)		N/A						
Intel Optane Storage Technology		N/A						
Disclaimers								

Solid State Storage Devices

Supported Types		M.2						
Dimensions inches/centimeters (W x D x H)		22.0 (+-0.15) x 80.0 (+-0.15) x 2.3 (max)						
Size		M.2 2280S3						
Interface Type		PCIe NVMe Gen4						
Read/Write IOPS Specifications		Performance PCIe Gen4 Read: 700k (2TB), 600k (1TB) Write: 600k (2TB, 1TB) Value PCIe Gen4 Read: 300k (1TB), 250k (512GB), 200k (256GB) Write: 240k (1TB, 512GB), 190k (256GB)						
Bandwidth Performance		PCIe Gen4 x 4 (16Gbps)						
Power Consumption (Max)		3.0A (10us average)						
Active(AVG)		5W						
Idle		5mW (L1.2)						
Min MTBF		2'000'000						
Min Sequential Read		Performance PCIe Gen4 6400MB/s (2TB, 1TB) Value PCIe Gen4 3500MB/s (1TB, 512GB),						

		3200MB/s (256GB)						
Min Sequential Write		Performance PCIe Gen4 5000MB/s (2TB), 4400MB/s (1TB) Value PCIe Gen4 2900MB/s (1TB), 2500MB/s (512GB), 1800MB/s (256GB)						
Hardware Encryption		Yes						
Disclaimers								

Discrete Graphics Adapter

GPU Name		N/A						
CUDA Processing Cores		N/A						
GPU Memory		N/A						
Memory Bandwidth		N/A						
Memory Type		N/A						
Memory Interface		N/A						
TGP Max Power Consumption		N/A						
Display Port		N/A						
OpenGL		N/A						
Shader Model		N/A						

DirectX		N/A						
PCIe Generation		N/A						
Floating-Point Performance		N/A						
VR Ready		N/A						
Simultaneous Multi-Projection		N/A						
NVIDIA FXAA/TXAA Antialiasing		N/A						
NVIDIA nView Display Management Technology		N/A						
GPU Direct for Video		N/A						
Vulkan Support		N/A						
NVIDIA Optimus		N/A						
Disclaimers								

WLAN

Model		MTK MT7925						
Connector: Main, Aux/GNSS, GNSS		ANT1:AUX WiFi + BT; ANT2: Main WiFi						
Antenna Diversity		Supported						
MIMO		Not supported						

GNSS Bian		N/A						
Radio ON/OFF Control		Supported						
Connector interface		PCIE						
Operating Temperature (Adapter Shield)		0c to +80c						
Humidity Non- Operating		50%~90% Rh non condensing (at temperatures of 25c to 35c)						
Operating Systems		Microsoft Windows 11, Linux						
Wi-Fi Alliance		Wi-Fi CERTIFIED* a/b/g/n/ac, WMM*, WMM-PS*, WPA*, WPA2*, WPS2*, Protected Management Frames, Wi-Fi Direct* for peer to peer device connections, Wi-Fi Miracast* as Source.						
IEEE WLAN Standard		IEEE 802.11a/b/g/n/ ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w; 802.11r, 802.11k, 802.11v pending OS						

		support; Fine Timing Measurement based on 802.11REVmc						
Roaming		Support seamless roaming between access points						
Bluetooth*		Dual Mode Bluetooth® 5.3						
Authentication		WPA and WPA2, 802.1X (EAP-TLS, TTLS, PEAP, LEAP, EAP-FAST), EAP-SIM, EAP-AKA, EAP-AKA						
Authentication Protocols		PAP, CHAP, TLS, MS-CHAP*, MS-CHAPv2						
Encryption		64-bit and 128-bit WEP, 128-bit AES-CCMP						
Regulatory		For a list of country approvals, please contact your local Intel representatives.						
US Government		FIPS10, FISMA						
Product Safety		UL,C-UL,CB (IEC 60950-1)						
Disclaimers								

Battery

Dimension		270mm*69.7mm*6.41mm	270mm*69.7mm*6.16mm					
Weight		247g	217g					
Type (Chemistry and Cell)		Li-ion Polymer	Li-ion Polymer					
Voltage		15.44V~15.48V	15.6V					
Battery Life								
Battery Capacity		Integrated 4-cell 52.5Wh battery	Integrated 4-cell 57Wh battery					
Charging Time		in-operation: 2.1h 0~100%	in-operation: 1.97h 0~100%					
Operating Temperature Range		off: 1h 0~80%, 2.05h 0~100%	off: 1h 0~80%, 2h 0~100%					
Warranty		Between 10°C and 35°C	Between 10°C and 35°C					
Coin Cell Battery (Model)		1 Year / 3 Year Available	1 Year / 3 Year Available					
Disclaimers								

SECTION IV: BIOS / Certifications / Standards / Environmental

BIOS Specifications

WMI Support		Yes, if it is BIOS Setup change by WMI.						
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ROM-Based Setup Utility (F1)		Yes						
Bootblock Recovery		N/A						
Replicated Setup		Yes, it supported with SRSETUP tool.						
Boot Control		Yes, it means Boot order change.						
Discrete Mode								
Memory Change Alert		N/A						
Thermal Alert		N/A						
Asset Tag		Yes						
System/Emergency ROM Flash Recovery with Video		N/A						
Remote Wakeup/Remote Shutdown		Yes, if Remote wakeup is Wake on LAN from S4/S5.						
Keyboard-less Operation		N/A						
Per-port Control		Yes, if it is I/O port enable/disable by BIOS Setup.						
Adaptive Cooling		Yes, if it is thermal & fan control.						
Security		Yes, BIOS password / Hard disk						

		password / Finger print						
Intel(R) AMT (includes ASF 2.0)		Yes. If you select vPro model						
Intel(R) TXT		Yes. If you select vPro model						
Memory Modes		N/A						
UEFI						Unified Extensible Firmware Interface 2.7		

EMC & Safety

EMC		Published, Certified Existing Reports EMC – Australia EMC – Belarus EMC – Canada EMC – China EMC – EU/EFTA EMC – Japan EMC – Kazakhstan EMC – New Zealand EMC – Russia EMC – South Korea EMC – Taiwan EMC – USA/Territorie s Not Applicable / Not Required EMC – Israel EMC – Moldova EMC – Serbia EMC – Turkey						
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		EMC – Uzbekistan EMC – Vietnam						
Safety		To access the latest User Guide and Safety and Warranty Guide, go to: https://support.lenovo.com Low Halogen Declaration of Conformance TNOT-2017-0040 Section 9 – Low Halogen Scorecard Izod Test – EPEAT Compliant Homologation PCR B Compliant In the following countries: Albania, Algeria, Andorra, Angola, Antigua and Barbuda, Argentina, Armenia, Aruba, Australia, Azerbaijan, Bahamas, Bahrain, Bangladesh, Barbados, Belarus, Belize, Benin, Bermuda, Bolivia, Botswana, Burkina Faso, Burundi, Cambodia, Cameroon, Canada, Cape						

Verde, Cayman Islands, Central African Republic, Chad, China, Colombia, Comoros, Congo, Costa Rica, Djibouti, Dominican Republic, Egypt, El Salvador, Eritrea, Ethiopia, EU/EFTA, Fiji, Gabon, Gambia, Georgia, Ghana, Grenada, Guatemala, Guinea, Haiti, Honduras, Hong Kong, India, Indonesia, Israel, Jamaica, Japan, Jordan, Kazakhstan, Kenya, Kuwait, Laos, Lebanon, Liberia, Macau, Madagascar, Malawi, Malaysia, Mali, Mauritania, Mauritius, Mexico, Moldova, Mongolia, Morocco, Mozambique, Namibia, Nepal, New Zealand, Nicaragua, Niger, Nigeria, Oman,								
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		Pakistan, Panama, Papua New Guinea, Paraguay, Peru, Philippines, Qatar, Russia, Saudi Arabia, Senegal, Serbia, Seychelles, Sierra Leone, Singapore, South Africa, South Korea, Sri Lanka, Swaziland, Taiwan, Tajikistan, Tanzania, Thailand, Togo, Tunisia, Turkey, Turkmenistan , Uganda, Ukraine, United Arab Emirates, Uruguay, USA/Territorie s, Uzbekistan, Venezuela, Vietnam, Zambia, Zimbabwe, Brazil – Inmetro 170 Govt Bids, Guinea- Bissau, Lesotho						
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Environmentals

Energy Star		ENERGY STAR® Version 9.0 For more information about						
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		ENERGY STAR, go to: https://www.energystar.gov						
EPEAT		EPEAT Declaration of Conformance For Machine Types: 20S4, 20S5						
IT ECO declaration		The latest environmental information about Lenovo products is available at: https://www.lenovo.com/eco-declaration						
Hazardous Substances		The latest environmental information about Lenovo products is available at: https://www.lenovo.com/eco-declaration European Union RoHS This Lenovo product, with included parts (cables, cords, and so on) meets the requirements of Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("RoHS recast" or "RoHS 2"). For more information						

		about Lenovo worldwide compliance on RoHS, go to: https://www.lenovo.com/rohs-communication						
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Manageability

Industry Standard Specifications		This product meets the following industry standard specifications for manageability functionality: Intel LAN with AMT						
Remote Manageability Software Solutions		Lenovo ThinkManagement Console Microsoft System Center Configuration Manager LANDesk Management Suite for ThinkVantage Technologies (www.landesk.com/lenovo)						
System Software Manager		Lenovo ThinkPad supports software management tools from the Lenovo Vantage						

		System Update suite: System Update Update Retriever						
Service, Support, and Warranty		On-site Warranty and Service: Three-years, limited warranty and service offering delivers on-site, next business-day service for parts and labor and includes free telephone support 8am to 5pm. Global coverage ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.						

Environmentals

Energy Star		ENERGY STAR® 9.0						
EPEAT		EPEAT® Gold						

RoHS Compliant		RoHS Compliant						
TCO		TCO 9.0						
Sustainability		97% PCC recycled plastic: Speaker enclosure 97% recycled plastic: 52.5W hr Battery 95% PCC recycled plastic: 65W PSU 90% recycled/sustainable packaging Low-temperature solder						
Disclaimers		Product packaging shall contain, on average, a minimum total percentage of 90% by weight of any combination of the following materials: Recycled content, biobased plastic, non-wood biobased fiber material, and/or sustainably forested material.						

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